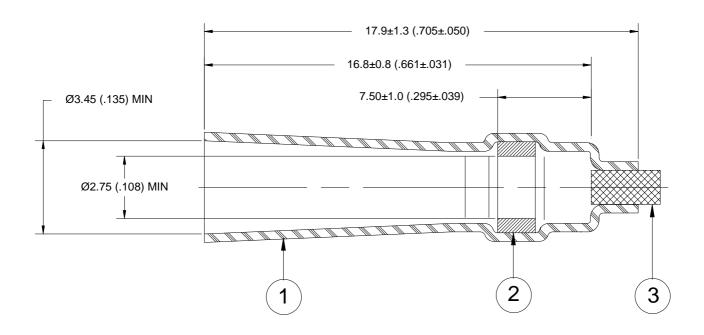
CUSTOMER DRAWING



MATERIALS

- 1. INSULATION SLEEVE: Heat-shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
- 2. SOLDER PREFORM WITH FLUX:
 - SOLDER: TYPE Sn63 per ANSI-J-STD-006.
- FLUX: TYPE ROL1 per ANSI-J-STD-004.
- 3. END CLOSURE: Thermally stabilized thermoplastic.

APPLICATION

- 1. This part is designed to make a stub splice with wires having a combined conductor CMA of between 350 and 1400 circular mils and a combined jacket diameter between 1.27 (.050) and 3.40 (.135).
- 2. Part may be installed by convection heating.
- 3. Temperature range: -55°C to +150°C.

TE Connectivity			nectivity	Raychem Devices CUSTOMER DRAWING	TITLE: SOLDERSLEEVE* STUB SPLICE		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.					DOCUMENT NO: D-110-0172		
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ANGLES: N/A ROUGHNESS IN MICRON		Raychem reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.		REV: B	DATE: Octo	ber 11, 2013
DRAWN BY: T.NGUYEN		CAGE	E CODE: 06090	ECO NUMBER: 13-015998	SCALE: NTS	SIZE: A	SHEET: 1 of 1

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